1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Product Summary (@ T_A = +25°C)

V_{RRM} (V)	I_O (A)	V_F Max (V)	I_R Max (µA)
1,000	1	1.1	10

Features and Benefits

- Glass Passivated Die Construction
- Ideally Suited for Automated Assembly
- Small Form Factor, Low Profile
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **An Automotive-Compliant Part is Available Under Separate Datasheet (S1MSWFQ)**

Description and Applications

The S1MSWF is a rectifier packaged in the SOD123F (Type B). Providing high reverse breakdown voltage and high current capability for standard rectification, this device is ideal for use in general rectification applications such as:

- Switching Mode Power Supply Applications
- DC-DC Converter Applications
- AC-DC Adaptors/Chargers
- Mobile Devices
- LED Lighting

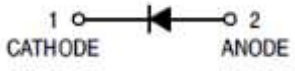
Mechanical Data

- Case: SOD123F (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Polarity: Cathode Band
- Weight: 0.018grams (Approximate)

SOD123F (Type B)

Top View

Bottom View



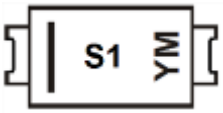
Schematic View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
S1MSWF-7	AEC-Q101	SOD123F (Type B)	3,000/Tape & Reel

Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



S1 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex.: C = 2015)
M = Month (ex: 9 = September)

Date Code Key

Year	2015	2016	2017	2018	2019	2020	2021	2022
Code	C	D	E	F	G	H	I	J

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_{RM}	1,000	V
RMS Reverse Voltage	$V_{R(RMS)}$	700	V
Average Rectified Output Current (@T_A = +75°C)	I_O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	25	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	13	°C/W
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	78	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	1,000	—	—	V	I_R = 5μA
Forward Voltage Drop	V_F	—	0.98 0.88	1.1 —	V	I_F = 1A, T_J = +25°C I_F = 1A, T_J = +125°C
Leakage Current (Note 6)	I_R	—	0.2 11	10 100	μA	V_R = 1,000V, T_J = +25°C V_R = 1,000V, T_J = +125°C
Reverse Recovery Time	t_{RR}	—	1.0	—	μs	I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A
Total Capacitance	C_T	—	6	—	pF	V_R = 4.0V_{DC}, f = 1MHz

Notes: 5. Device mounted on FR4 PC board, 1 inch x 1 inch, 2oz. copper traces with 1x recommended pad layout per http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.

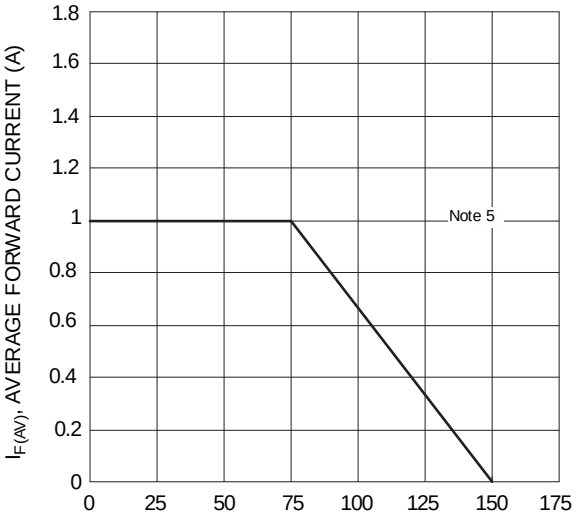


Figure 1 DC Forward Current Derating Curve

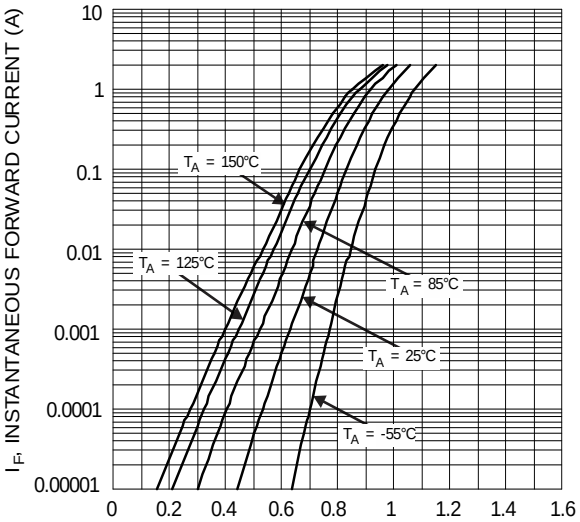


Figure 2 Typical Forward Characteristics

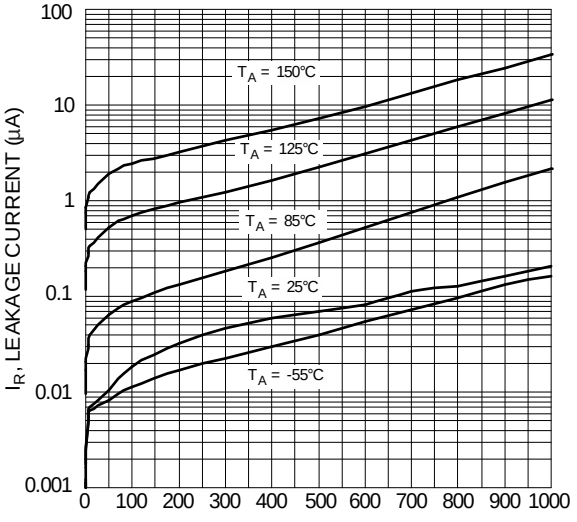


Figure 3 Typical Reverse Characteristics

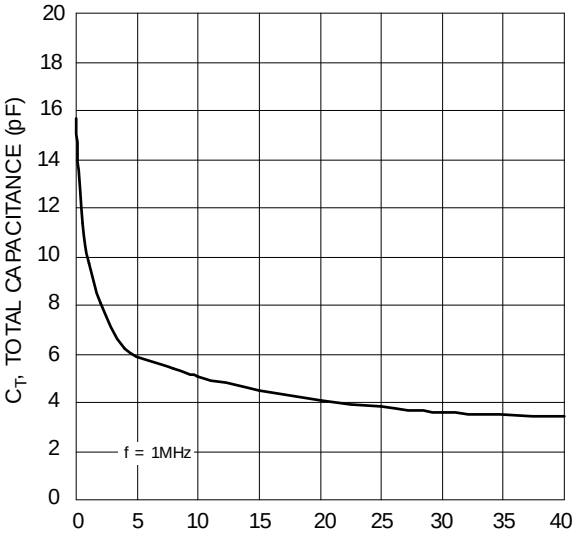
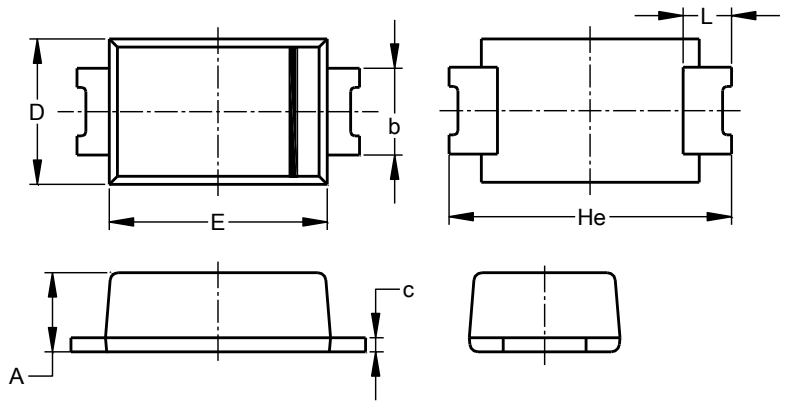


Figure 4 Typical Total Capacitance

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Type B)

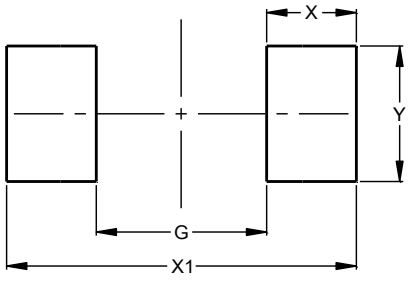


SOD123F (Type B)			
Dim	**Min**	**Max**	**Typ**
A	0.81	1.15	—
b	0.80	1.35	—
c	0.05	0.30	—
D	1.70	1.90	1.80
E	2.60	2.80	2.70
He	3.30	3.70	3.50
L	0.35	0.85	—
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Type B)



Dimensions	Value (in mm)
G	1.90
X	1.00
X1	3.90
Y	1.50

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